

16 A Three-quadrant triacs high commutation Rev. 01 — 11 April 2007

Product data sheet

1. **Product profile**

1.1 General description

Passivated, new generation, high commutation triacs in a SOT186A isolated full pack plastic package

1.2 Features

- Very high commutation performance maximized at each gate sensitivity
- High isolation voltage

1.3 Applications

- High power motor control e.g. washing Refrigeration and air conditioning machines and vacuum cleaners
- Non-linear rectifier-fed motor loads.

1.4 Quick reference data

- V_{DRM} \leq 600 V (BTA316X-600B/C/E)
- V_{DRM} ≤ 800 V (BTA316X-800B/C/E)
- I_{TSM} \leq 140 A (t = 20 ms)
- I_{T(RMS)} \leq 16 A

- High immunity to dV/dt
- Wide range of gate sensitivities
- compressors
- Electronic thermostats

2 SOT186A (TO-220F)

- I_{GT} \leq 50 mA (BTA316X series B)
- I_{GT} ≤ 35 mA (BTA316X series C)
- I_{GT} \leq 10 mA (BTA316X series E)

Pinning information 2.

Pin	Description	Simplified outline	Symbol
1	main terminal 1 (T1)		
2	main terminal 2 (T2)	mb	T2-T1
3	gate (G)		Sym051
mb	mounting base; isolated		
		ĨĨ	



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3. Ordering information

Type number	Package								
	Name	Description	Version						
BTA316X-600B	TO-220F	20F plastic single-ended package; isolated heatsink mounted; 1 mounting hole; 3-lead TO-220 'full pack'							
BTA316X-600C									
BTA316X-600E									
BTA316X-800B									
BTA316X-800C									
BTA316X-800E									

4. Limiting values

Table 3. Limiting values

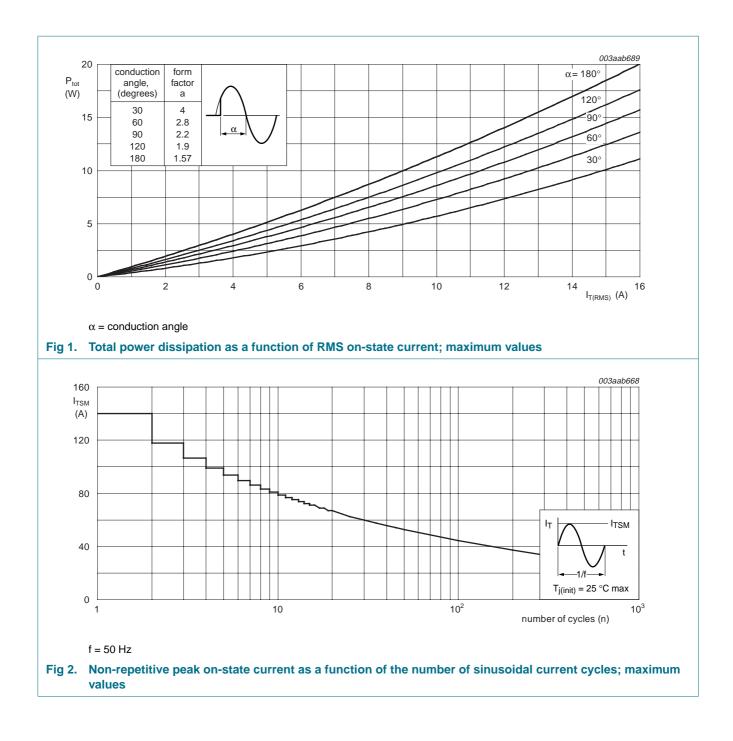
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage	BTA316X-600B; BTA316X-600C; BTA316X-600E	<u>[1]</u> _	600	V
	BTA316X-800B; BTA316X-800C; BTA316X-800E	-	800	V	
I _{T(RMS)}	RMS on-state current	full sine wave; T _h ≤ 45 °C; see <u>Figure 4</u> and <u>5</u>	-	16	A
I _{TSM} non-repetitive peak on-state current		full sine wave; $T_j = 25 \text{ °C prior to}$ surge; see Figure 2 and 3			
		t = 20 ms	-	140	А
		t = 16.7 ms	-	150	А
l ² t	l ² t for fusing	t = 10 ms	-	98	A ² s
dl _T /dt	rate of rise of on-state current	$\begin{split} I_{TM} &= 20 \text{ A}; \text{ I}_{G} = 0.2 \text{ A}; \\ dI_{G}/dt &= 0.2 \text{ A}/\mu \text{s} \end{split}$	-	100	A/μs
I _{GM}	peak gate current		-	2	А
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	+150	°C
Tj	junction temperature		-	125	°C

[1] Although not recommended, off-state voltages up to 800 V may be applied without damage, but the triac may switch to the on-state. The rate of rise of current should not exceed 15 A/μs.

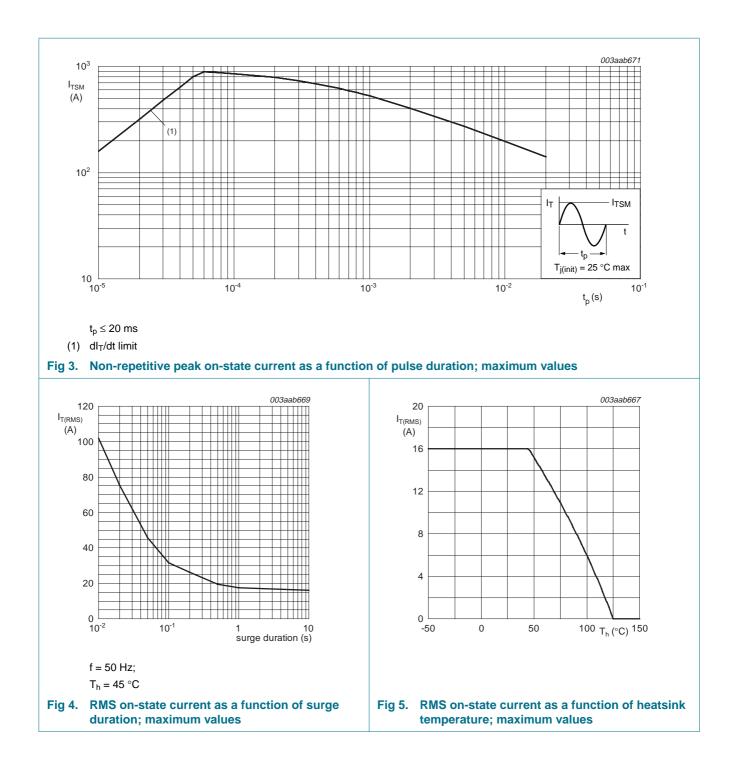
BTA316X series B, C and E

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BTA316X series B, C and E

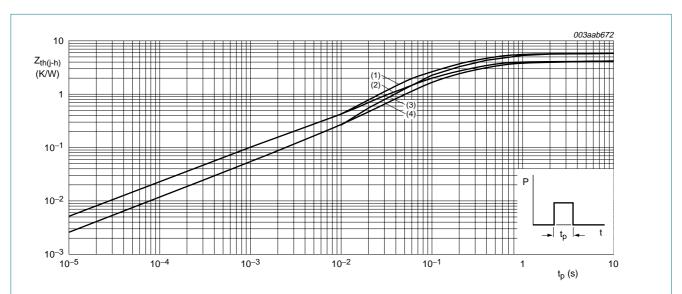
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5. Thermal characteristics

Table 4.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-h)}	thermal resistance from junction to heatsink	full or half cycle without heatsink compound; see <u>Figure 6</u>	-	-	5.5	K/W
		full or half cycle with heatsink compound; see Figure 6	-	-	4.0	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	55	-	K/W



- (1) Unidirectional (half cycle) without heatsink compound
- (2) Unidirectional (half cycle) with heatsink compound
- (3) Bidirectional (full cycle) without heatsink compound
- (4) Bidirectional (full cycle) with heatsink compound
- Fig 6. Transient thermal impedance from junction to heatsink as a function of pulse duration

6. Isolation characteristics

Table 5. Isolation limiting values and characteristics $T = 25 \degree$ C unloss otherwise specified

$T_h = 25 ^{\circ}C unless$	s otherwise sp	ecified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{isol} (RMS)	RMS isolation voltage	from all three terminals to external heatsink; f = 50 Hz to 60 Hz; sinusoidal waveform; RH \leq 65 %; clean and dust free	-	-	2500	V
C _{isol}	isolation capacitance	from pin 2 to external heatsink; f = 1 MHz	-	10	-	pF

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7. Static characteristics

Table 6.Static characteristics

 $T_i = 25 \circ C$ unless otherwise specified.

Symbol	Parameter	Conditions		A316X- A316X-		BTA316X-600C BTA316X-800C				BTA316X-600E BTA316X-800E		
			Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	_
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; see <u>Figure 8</u>										
		T2+ G+	2	-	50	2	-	35	-	-	10	mA
		T2+ G–	2	-	50	2	-	35	-	-	10	mA
		T2– G–	2	-	50	2	-	35	-	-	10	mA
IL latching current	latching current	$V_D = 12 V;$ I _{GT} = 0.1 A; see <u>Figure 10</u>										
		T2+ G+	-	-	60	-	-	50	-	-	25	mA
		T2+ G–	-	-	90	-	-	60	-	-	30	mA
		T2– G–	-	-	60	-	-	50	-	-	30	mA
I _H	holding current	$V_D = 12 V;$ I _{GT} = 0.1 A; see <u>Figure 11</u>	-	-	60	-	-	35	-	-	15	mA
V _T	on-state voltage	I _T = 18 A; see <u>Figure 9</u>	-	1.3	1.5	-	1.3	1.5	-	1.3	1.5	V
	gate trigger voltage	$V_D = 12 V;$ $I_T = 0.1 A;$ see <u>Figure 7</u>	-	0.8	1.5	-	0.8	1.5	-	0.8	1.5	V
		$V_D = 400 V;$ $I_T = 0.1 A;$ $T_j = 125 \ ^{\circ}C$	0.25	0.4	-	0.25	0.4	-	0.25	0.4	-	V
I _D	off-state current	$V_D = V_{DRM(max)};$ $T_j = 125 \ ^{\circ}C$	-	0.1	0.5	-	0.1	0.5	-	0.1	0.5	mA

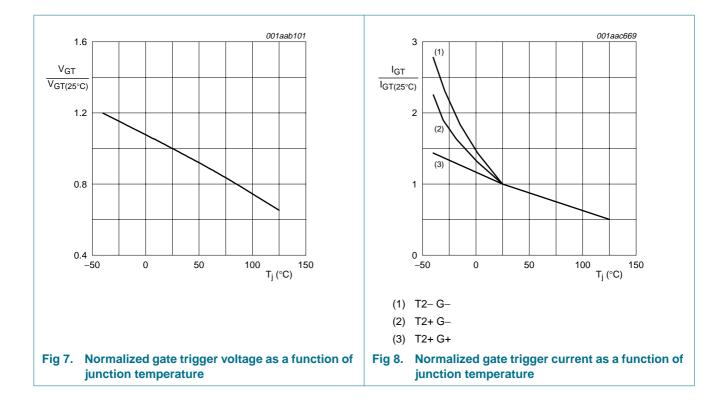
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8. Dynamic characteristics

Symbol	Parameter	Conditions		BTA316X-600B BTA316X-800B		BTA316X-600C BTA316X-800C		BTA316X-600E BTA316X-800E			Unit	
			Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	
dV _D /dt	rate of rise of off-state voltage	$\begin{split} V_{DM} &= 0.67 \times \\ V_{DRM(max)}; \\ T_j &= 125 \ ^\circ\text{C}; \\ exponential \\ waveform; gate open \\ circuit \end{split}$	1000	-	-	500	-	-	60	-	-	V/µs
of	commutating	$\label{eq:VDM} \begin{split} V_{DM} &= 400 \text{ V};\\ T_j &= 125 \ ^\circ\text{C};\\ I_{T(RMS)} &= 16 \text{ A};\\ \text{without snubber};\\ \text{gate open circuit} \end{split}$	20	-	-	15	-	-	5	-	-	A/ms
		$V_{DM} = 400 \text{ V};$ $T_j = 125 \text{ °C};$ $I_{T(RMS)} = 16 \text{ A};$ $dV/dt = 10 \text{ V}/\mu \text{s};$ gate open circuit	-	-	-	-	-	-	8	-	-	A/ms
		$\begin{split} V_{DM} &= 400 \text{ V}; \\ T_{j} &= 125 \text{ °C}; \\ I_{T(RMS)} &= 16 \text{ A}; \\ dV/dt &= 1 \text{ V}/\mu \text{s}; \text{ gate} \\ \text{open circuit} \end{split}$	-	-	-	-	-	-	12	-	-	A/ms
t _{gt}	gate-controlled turn-on time	$\begin{split} I_{TM} &= 20 \text{ A};\\ V_D &= V_{DRM(max)};\\ I_G &= 0.1 \text{ A};\\ dI_G/dt &= 5 \text{ A}/\mu\text{s} \end{split}$	-	2	-	-	2	-	-	2	-	μs

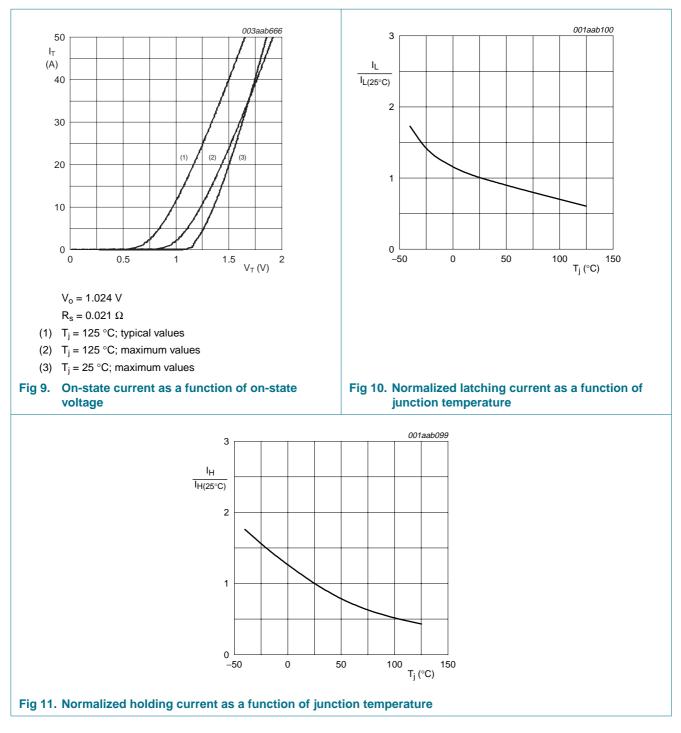
BTA316X series B, C and E

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BTA316X series B, C and E

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9. Package information

Epoxy meets UL94 V-0 at 3.175 mm

BTA316X_SER_B_C_E_1

BTA316X series B, C and E

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10. Package outline

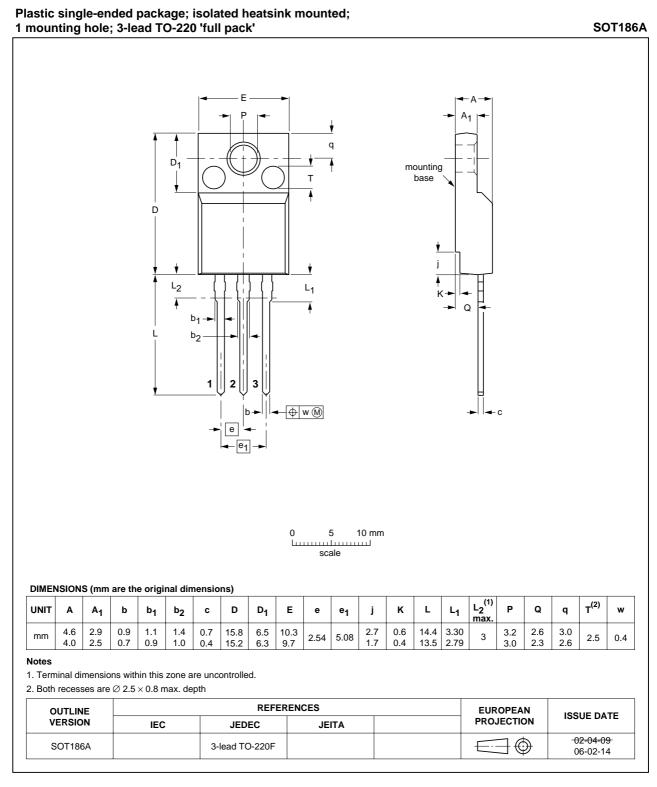


Fig 12. Package outline SOT186A (TO-220F)

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11. Revision history

Table 8. Revision histor	у			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BTA316X_SER_B_C_E_1	20070411	Product data sheet	-	-

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12. Legal information

12.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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Product [short] data sheet	Production	This document contains the product specification.

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[2] The term 'short data sheet' is explained in section "Definitions".

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